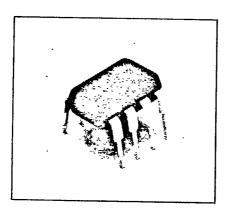
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SIEMENS

T-41-85 6N138 6N139

LOW INPUT CURRENT, HIGH GAIN OPTOCOUPLER



FEATURES

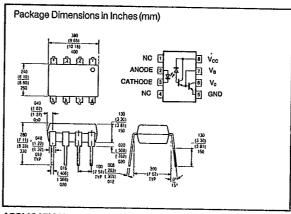
- 6000 Volt Isolation Voltage
- High Current Transfer Ratio 800%
- Low Input Current Requirement 0.5mA
- TTL Compatible Output 0.1V VOL
- High Common Mode Rejection 500V/µsec.
- High Output Current ~ 60mA
- DC to 1 Megabit / Sec. Operation
- Adjustable Bandwidth Access to Base
- Standard Molded Dip Plastic Package
- UL Approval # E52744

DESCRIPTION

High common mode transient immunity and very high current transfer ratio together with 6000 volts DC Insulation are achieved by coupling an LED with an integrated high gain photon detector in an 8 pin dual inline package. Separate pins for the photodiode and output stage enable TTL compatible saturation voltages with high speed operation. Photo Darlington operation is achieved by tying the Vcc and Vo terminals together. Access to the base terminal allows adjustment to the gain bandwidth.

The 6N138 is Ideal for TTL applications since the 300% minimum current transfer ratio with an LED current of 1.6mA enables operation with 1 unit load in and 1 unit load out with a 2.2K Ω pull-up resistor.

The 6N139 is best suited for low power logic applications involving CMOS and low power TTL. A 400% current transfer ratio with only 0.5mA of LED current is guaranteed from 0°C to 70°C.



APPLICATIONS

- Logic ground isolation TTL/TTL, TTL/CMOS, CMOS/CMOS, CMOS/TTL
- EIA RS 232C Line Receiver
- Low Input Current Line Receiver Long Lines, Party Lines
- Telephone Ring Detector
- 117 VAC Line Voltage Status Indication—Low Input Power Dissipation
- Low Power Systems Ground Isolation

Maximum Ratings

Maximum Temperatures Storage Temperatures -55° to +125°C Operating Temperatures 0°C to +70°C Lead Temperature (soldering, 10 sec.)
Average Input Current (I_F) 260°C Peak Input Current (I_F)

(50% Duty Cycle — 1ms pulse width)

Reverse Input Voltage (V_R)

Input Power Dissipation 40mA 35mW (Derate linearly above 50% in free air temperature at 0.7mW/°C) Output Current — I_o (Pin 6) 60mA (Derate linearly above 25 °C in free air temperature at 0.7mA/°C) Emitter-Base Reverse Voltage (Pin 5-7) Supply and Outage Voltage — V_{CC} (Pin 8-5), V_{o} (Pin 6-5) 6N138 6N139 -0.5 to 18V **Output Power Dissipation** 100mW (Derate Linearly Above 25°C in Free Air Temperature at 2.0mW/°C) Caution

Due to the small geometries of this device it should be handled with Electrostatic Discharge (ESD) precautions. Proper grounding would further prevent damage and/or degradation which may be induced by ESD.

Electro-Optical Characteristics ($T_A = 0$ °C to 70°C, Unless Otherwise Specified)

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Parameter	Device	Min	Тур	Max	Units	Test Conditions	Note
Current Transfer Ratio (CTR)	6N139	400 500	800 900		%	$I_F = 0.5$ mA, $V_0 = 0.4$ V, $V_{CC} = 4.5$ V $I_F = 1.6$ mA, $V_0 = 0.4$ V, $V_{CC} = 4.5$ V	5,6
	6N138	300	600		%	$I_F = 1.6 \text{mA}, V_0 = 0.4 \text{V}, V_{CC} = 4.5 \text{V}$	l
Logic Low Output Voltage (VOL)	6N139 6N139 6N139		0.1 0.1 0.2	0.4 0.4 0.4	٧	$I_{\rm F}$ = 1.6mA, $I_{\rm o}$ = 6.4mA, $V_{\rm CC}$ = 4.5V $I_{\rm F}$ = 5mA, $I_{\rm o}$ = 15mA, $V_{\rm CC}$ = 4.5V $I_{\rm F}$ = 12mA, $I_{\rm o}$ = 24mA, $V_{\rm CC}$ = 4.5V	6
	6N138		0.1	0.4	٧	$I_F = 1.6 \text{mA}, I_o = 4.8 \text{mA}, V_{CC} = 4.5 \text{V}$	6
Logic High	6N139		0.05	100	μΑ	$I_{\rm F} = 0$ mA, $V_{\rm o} = V_{\rm CC} = 18V$	6
Output Current (IOH)	6N138		0.1	250	μA	$I_{\rm F} = 0 \text{mA}, \ V_{\rm o} = V_{\rm CC} = 7 \text{V}$	
Logic Low Supply Current (ICCL)				0.2	mA	$I_F = 1.6$ mA, $V_0 = OPEN$, $V_{CC} = 5$ v	6
Logic High Supply Current (ICCH)				10	mA	$I_{\rm F} = 0$ mA, $V_{\rm o} = 0$ PEN, $V_{\rm CC} = 5$ v	6
Input Forward Voltage (VF)			1.4	1.7	٧	$I_{\rm F} = 1.6 {\rm mA}, \ T_{\rm A} = 25 {\rm ^{\circ}C}$	
Input Reverse Breakdown Voltage (BVR)		5			٧	I _R = 10uA, T _A = 25 °C	
Temperature Coefficient of Forward Voltage			1.8		mV/°c	<i>I_F</i> = 1.6mA	
Input Capacitance (C _{IN})			60		ρF	$f = 1MH_z$, $V_F = 0$	
Input-Output Insulation Leakage Current (I ₁₋₀)				1.0	μА	45% Relative Humidity, $T_A = 25$ °C $t = 5_s$, $V_{1-0} = 3000$ VDC	7
Resistance Input-Output) (R _{1 o})			1012		Ω	$V_{t-o} = 500V_{DC}$	7
Capacitance (Input-Output) (C ₁₋₀)			0.6		ρF	f=1MH ₂	7

Switching Specifications (TA = 25°C)

Parameter	Device	Min	Тур	Max	Units	Test Conditions	Note
Propagation Delay Time	6N139	_	5 0.2	25 1	μS	$I_F = 0.5 \text{mA}, R_L = 4.7 \text{k}\Omega$ $I_F = 12 \text{mA}, R_L = 270 \Omega$	6,8
To Logic Low at Output tPHL	6N138		1	10	μѕ	$I_{\rm F} = 1.6 \text{mA}, R_{\rm L} = 2.2 \text{k}\Omega$	
Propagation Delay Time	6N139		5	60 7	μs	$I_F = 0.5 \text{mA}, R_L = 4.7 \text{k}\Omega$ $I_F = 12 \text{mA}, R_L = 270 \text{mA}\Omega$	6,8
To Logic High at Output tPLH	6N138		4	35	μS	$I_{\rm F} = 1.6 {\rm mA}, R_{\rm L} = 2.2 {\rm k}\Omega$	
Common Mode Transient Immunity at Logic High Level (CM _H) Output			500		v/μs	$I_{\rm F} = 0$ mA, $R_{\rm L} = 2.2$ kQ $R_{\rm CC} = 0.1$ V _{cm} $I = 10$ V _{p-p}	9,10
Common Mode Transient Immunity at Logic Low Level (CM _L) Output			- 500		V/μs	$I_F = 1.6 \text{mA}, R_L = 2.2 \text{k}\Omega$ $R_{CC} = 0./V_{CM} = 10V_{CD}$	9,10

Notes

- 1. Derate linearly above 50°C free-air temperature at a rate of 0.4mA/°C,
- 2. Derate linearly above 50 °C free-air temperature at a rate of 0.7mW/°C.
- 3. Derate linearly above 25°C free-air temperature at a rate of 0.7mA/°C.
- 4. Derate linearly above 25°C free-air temperature at a rate of 2.0mW/°C.
- 5. DC current transfer ratio is defined as the ratio of output collector current, Io, to the forward LED input current, Iptimes 100%
- 6. Pin 7 open.
- 7. Device considered a two-terminal device: pins 1,2,3 and 4 shorted together and pins 5,6,7, and 8 shorted together.
- 8. Use of a resistor between pin 5 and 7 will decrease gain and delay time.
- 9. Common mode transient immunity in logic high level is the maximum tolerable (positive) dVcm/dt on the leading edge of the common mode pulse, V_{cm} , to assure that the output will remain in a logic high state (i.e. $V_0 > 2.0V$) common mode transient immunity in logic low level is the maximum tolerable (negative) dVcm/dt on the trailing edge of the common mode pulse signal, V_{cm} , to assure that the output will remain in a logic low state (i.e. $V_p < 0.8V$).
- 10. In applications where dvidt may exceed \$0,000v/us (such as state discharge) a series resistor, R_{cc} should be included to protect I_c from destructively high surge currents. The recommended value us $R_{cc} \approx IV$ kQ. 0.15 /F (mA)

